

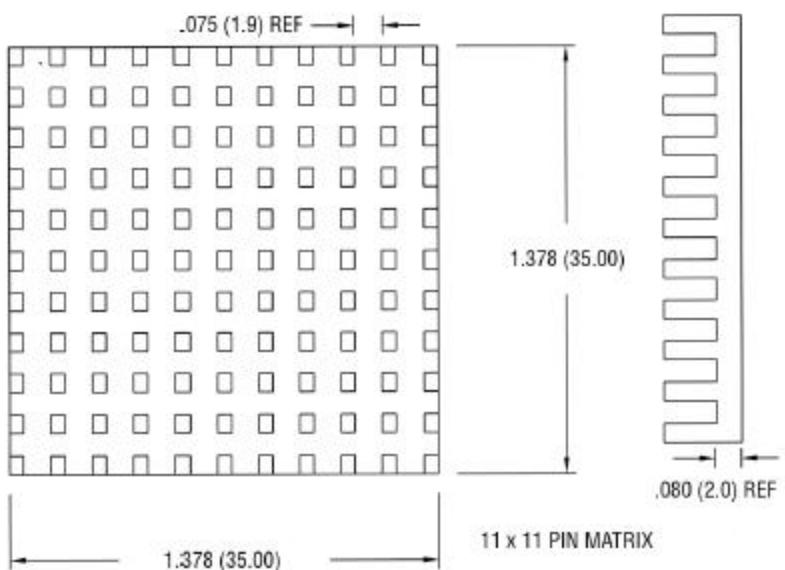
630 SERIES**Omnidirectional Pin Fin Heat Sink for BGAs**

Standard P/N	Base Dimensions in. Sq.	Fin Height "A" in. (mm)	Typical Applications	Weight lbs. (grams)
630-25AB	.1378 (35)	.250 (6.4)	35mm BGA	.009 (4.09)
630-35AB	.1378 (35)	.350 (8.9)	35mm BGA	.011 (4.99)
630-45AB	.1378 (35)	.450 (11.4)	35mm BGA	.015 (6.81)
630-60AB	.1378 (35)	.600 (15.2)	35mm BGA	.026 (11.80)

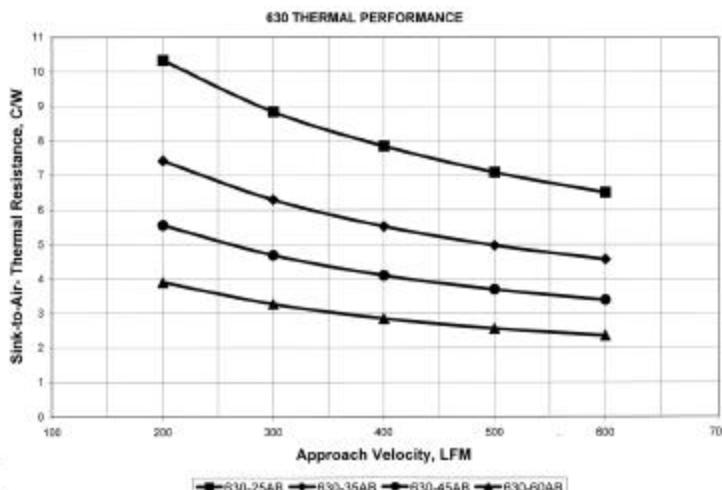
Material: Aluminum, Black Anodized

The 630 Series is an omnidirectional pin fin heat sink for both natural and forced-convection applications.

Applications include network routers and switches, high-resolution printers, digital cameras, consumer video games, digital video disks (DVD) and global positioning systems (GPS).

MECHANICAL DIMENSIONS**630 SERIES****PRODUCT FEATURES**

- Available in four standard heights, .25 inch, .35 inch, .45 inch, and .60 inch.
- Available with pressure sensitive adhesives for quick and easy mounting. See Page 3



Dimensions: in.

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